

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Chin-Fong Chiu	01/12/2010
Ying Zong Juang	01/12/2010
Hann Huei Tsai	01/12/2010
Sheng-Hsiang Tseng	01/12/2010
Chen Fu Lin	01/12/2010
RECEIVING PARTY DATA	
Name:	National Chip Implementation Center National Applied Research Laboratories
Street Address:	7F. No. 26, Prosperity Rd. 1, Science Park
City:	Hsinchu City
State/Country:	TAIWAN
Postal Code:	300
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	12708546
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ATTORNEY DOCKET NUMBER:	CHIP.0103
NAME OF SUBMITTER:	Juan Carlos A. Marquez

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**PATENT
 REEL: 023959 FRAME: 0201**

Total Attachments: 2
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ASSIGNMENT


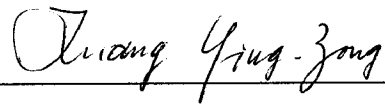
WHEREAS, 1. CHIU, Chin-Fong 2. JUANG, Ying Zong 3. TSAI, Hann Huei 4. TSENG, Sheng-Hsiang 5. LIN, Chen Fu whose post office addresses appear below hereinafter referred to as ASSIGNOR), have invented certain new and useful improvements in a CMOS-MEMS CANTILEVER STRUCTURE (hereinafter referred to as THE INVENTION) for which an application for United States Letters Patent was filed on _____, Application Number _____;


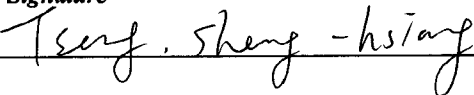

WHEREAS, NATIONAL CHIP IMPLEMENTATION CENTER NATIONAL APPLIED RESEARCH LABORATORIES, whose post office address is 7F, No. 26, Prosperity RD. 1, Science Park, Hsinchu City 300, Taiwan, R.O.C. (hereinafter referred to as ASSIGNEE), is desirous of acquiring the entire right, title and interest in and to the same in the United States and throughout the world;

NOW, THEREFORE, for good and valuable consideration, receipt of which is hereby acknowledged, we, ASSIGNOR, by these presents do sell, assign and transfer until said ASSIGNEE, the entire right, title and interest in and to said invention and application throughout the United States of America, including any and all United States Letters Patent granted on any division, continuation, continuation-in-part and reissue of said application; and the entire right, title and interest in and to said invention throughout the world, including the right to apply for patents and inventor certificates in respect thereof and to claim priority pursuant to rights accorded ASSIGNOR under the terms of the Paris International Convention and all other available international conventions and treaties; and the entire right, title and interest in and to any and all patents, patents of addition, utility models, patents of importation, revalidation patents and inventor certificates which may be granted throughout the world in respect of said invention.

ALSO, ASSIGNOR hereby agrees to execute any documents that legally may be required in connection with the filing, prosecution and maintenance of said application or any other patent application(s) or inventor certificate(s) in the United States and in foreign countries for said invention, including additional documents that may be required to affirm the rights of ASSIGNEE in and to said invention, all without further consideration. ASSIGNOR also agrees, without further consideration and at ASSIGNEE'S expense, to identify and communicate to ASSIGNEE at ASSIGNEE'S request documents and information concerning the invention that are within ASSIGNOR'S possession or control, and to provide further assurances and testimony on behalf of ASSIGNEE that lawfully may be required of ASSIGNOR in respect of the prosecution, maintenance and defense of any patent application or patent encompassed within the terms of this instrument. ASSIGNOR'S obligations under this instrument shall extend to ASSIGNOR'S heirs, executors, administrators and other legal representatives.

ASSIGNOR hereby authorizes and requests the Commissioner of Patents and Trademarks to issue any and all United States Letters Patent referred to above to ASSIGNEE of the entire right, title and interest in and to the same, for ASSIGNEE'S sole use and behalf; and for the use and behalf of ASSIGNEE'S legal representatives and successors, to the full end of the term for which such Letters Patent may be granted, as fully and entirely as the same would have been held by ASSIGNOR had this assignment and sale not been made.

Name	CHIU, Chin-Fong	Signature 
Address	7F, No. 26, Prosperity RD. 1, Science Park, Hsinchu City 300, Taiwan R.O.C.	Date January 12, 2010
Name	JUANG, Ying Zong	Signature 
Address	7F, No. 26, Prosperity RD. 1, Science Park, Hsinchu City 300, Taiwan R.O.C.	Date January 12, 2010

Name	TSAI, Hann Huei	<i>Signature</i> 
Address	7F, No. 26, Prosperity RD. 1, Science Park, Hsinchu City 300, Taiwan R.O.C.	<i>Date</i> January 12, 2010
Name	TSENG, Sheng-Hsiang	<i>Signature</i> 
Address	7F, No. 26, Prosperity RD. 1, Science Park, Hsinchu City 300, Taiwan R.O.C.	<i>Date</i> January 12, 2010
Name	LIN, Chen Fu	<i>Signature</i> 
Address	7F, No. 26, Prosperity RD. 1, Science Park, Hsinchu City 300, Taiwan R.O.C.	<i>Date</i> January 12, 2010